

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 5.5 A, 104 m $\Omega$

## **Features**

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 104 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 4.2 A
- Max  $r_{DS(on)}$  = 156 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 3.4 A
- HBM ESD protection level > 6 kV typical (Note 4)
- High performance trench technology for extremely low rDS(on)
- High power and current handling capability in a widely used surface mount package
- 100% UIL Tested
- RoHS Compliant

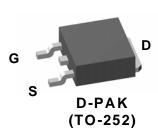


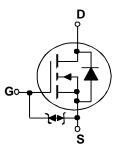
# General Description

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

# Application

■ DC-DC conversion





# MOSFET Maximum Ratings T<sub>C</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C		5.5		
	-Continuous	TA = 25 °C	(Note 1a)	4.2	Α	
	-Pulsed		15			
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 3)		(Note 3)	12	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		29		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.1		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

## **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	4.3	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	96	C/vv

## Package Marking and Ordering Information

Device Marking Device		Package	Reel Size	Tape Width	Quantity
FDD86113LZ	FDD86113LZ	D-PAK(TO-252)	PAK(TO-252) 13 " 16 mm		2500 units

# FDD86113LZ N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

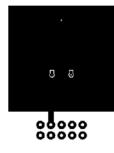
March 2015

Ð
D86
2
DD86113LZ N-Channel S
Z
Q
ล
Ξ
าย
-
ŝ
lie
ŏ
ē
0
Shielded Gate PowerTrench
Ite
Ť
ŏ
Ž
er
÷.
ē
Z
÷
⌀
Ζ
0
MOSFET
щ
-

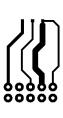
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100	1		V	
$\Delta BV_{DSS}$ $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		72		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	1	1.5	3	V	
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-5		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.2 A		87	104	mΩ	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3.4 A		116	156		
		$V_{GS} = 10 \text{ V}, I_{D} = 4.2 \text{ A}, T_{J} = 125 \text{ °C}$		142	170		
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, \ \text{I}_{D} = 4.2 \text{ A}$		9		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			213	285	pF	
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1MHz		55	75	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			2.4	5	pF	
R <sub>g</sub>	Gate Resistance			1.4		Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			3.6	10	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 4.2 A,		1.3	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		9.7	20	ns	
t <sub>f</sub>	Fall Time			1.6	10	ns	
Q <sub>g(TOT)</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		3.7	6	nC	
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 50 V,$		1.9	3		
Q <sub>gs</sub>	Gate to Source Charge	$I_{\rm D} = 4.2 \rm{A}$		0.6		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			0.7		nC	
Drain-Sou	urce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diede, Ecruverd Vellage	$V_{GS} = 0 V, I_{S} = 4.2 A$ (Note 2)		0.88	1.3	v	
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.7 A$ (Note 2)		0.80	1.2	v	
t <sub>rr</sub>	Reverse Recovery Time	- I <sub>F</sub> = 4.2 A, di/dt = 100 A/μs		31	49	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 4.2 \text{ A}, \text{ u/ul} = 100 \text{ A/}\mu\text{S}$		20	33	nC	

NOTES:

1. R<sub>0,1</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,1C</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



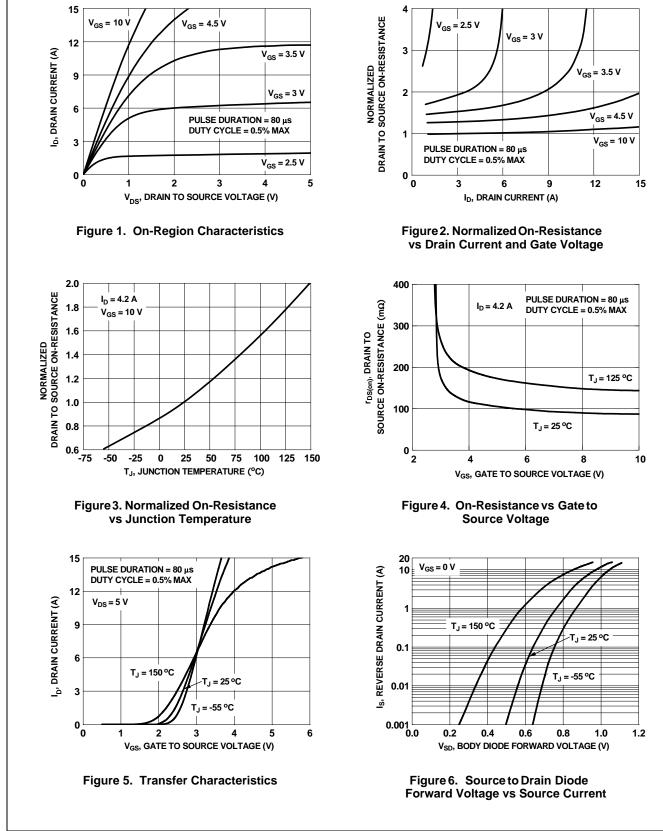
a) 40 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



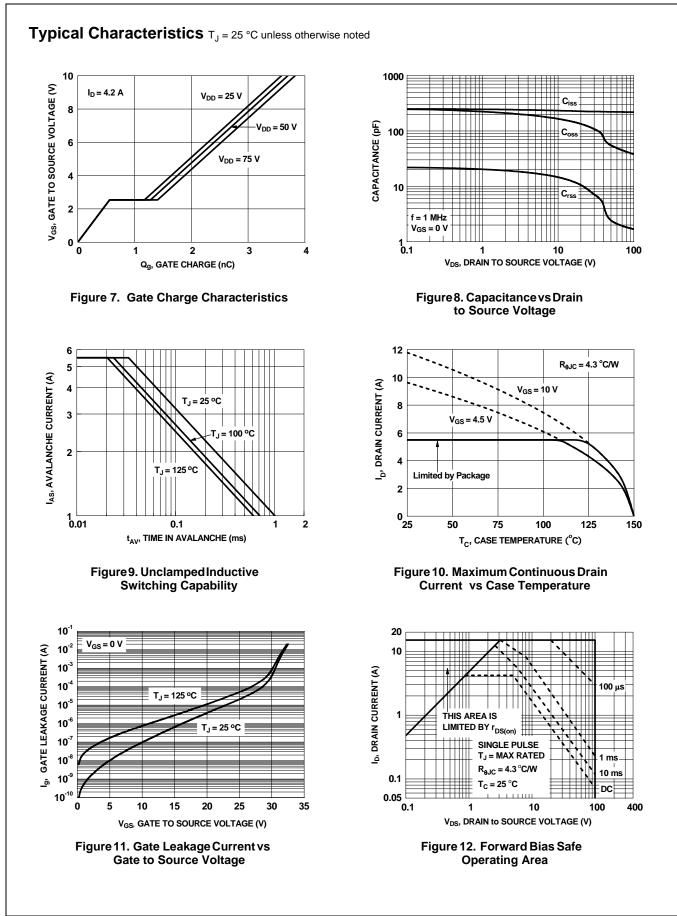
۰

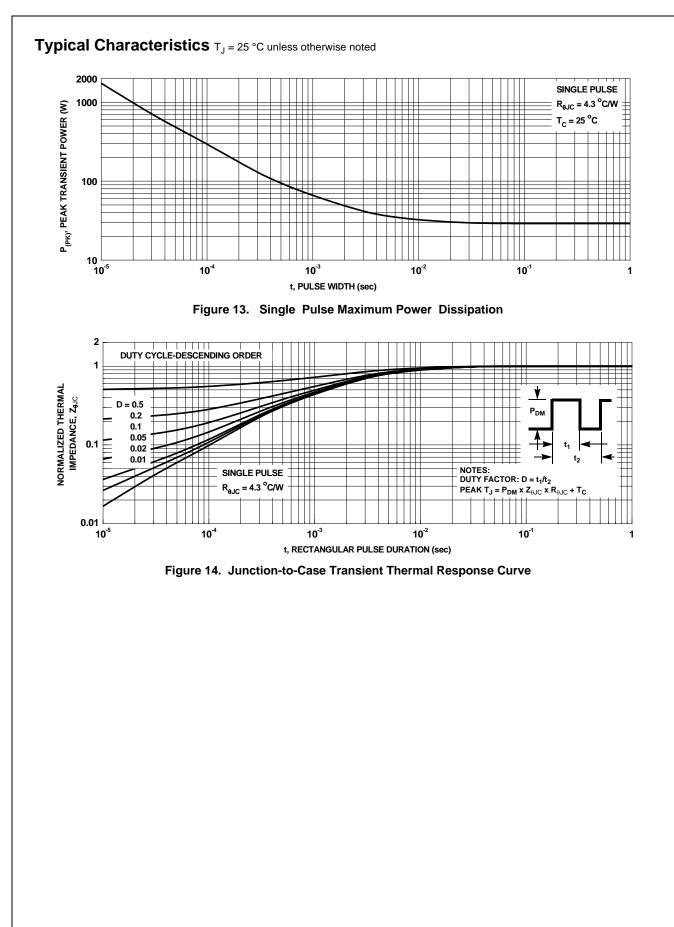
b) 96 °C/W when mounted on a minimum pad of 2 oz copper

Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0 %.</li>
Starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 5 A, V<sub>DD</sub> = 90 V, V<sub>GS</sub> = 10 V.
The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



# Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted





5





\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT <u>HTTP://WWW.FAIRCHILDSEMI.COM</u>, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

### AUTHORIZED USE

Unless otherwise specified in this data sheet, this product is a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability. This product may not be used in the following applications, unless specifically approved in writing by a Fairchild officer: (1) automotive or other transportation, (2) military/aerospace, (3) any safety critical application – including life critical medical equipment – where the failure of the Fairchild product reasonably would be expected to result in personal injury, death or property damage. Customer's use of this product is subject to agreement of this Authorized Use policy. In the event of an unauthorized use of Fairchild's product, Fairchild accepts no liability in the event of product failure. In other respects, this product shall be subject to Fairchild's Worldwide Terms and Conditions of Sale, unless a separate agreement has been signed by both Parties.

## ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Terms of Use

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

## PRODUCT STATUS DEFINITIONS

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 177

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: <u>FDD86113LZ</u>